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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

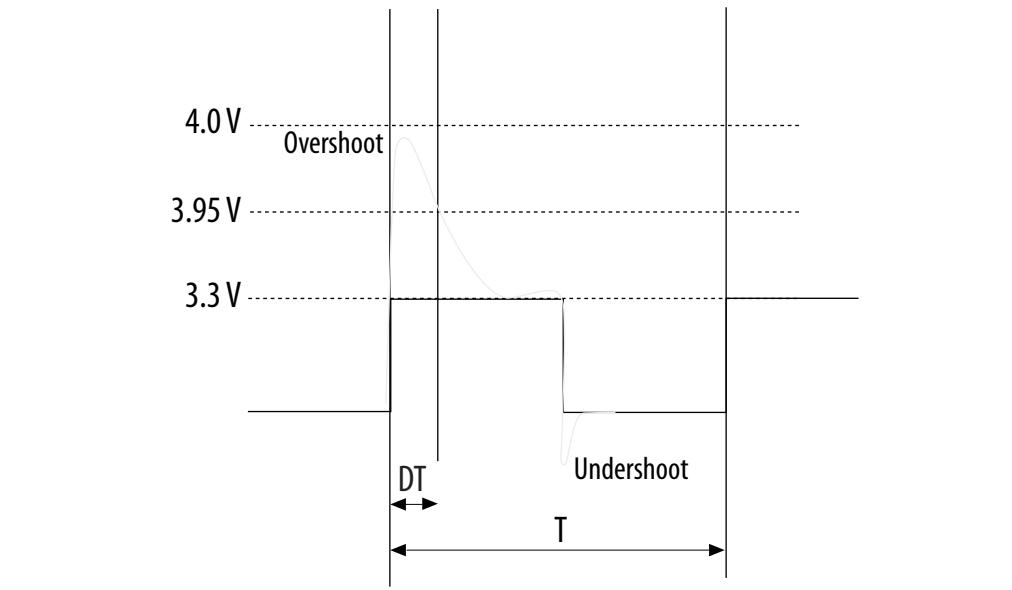
| | |
|--------------------------------|---|
| Product Status | Obsolete |
| Number of LABs/CLBs | 359200 |
| Number of Logic Elements/Cells | 952000 |
| Total RAM Bits | 53248000 |
| Number of I/O | 840 |
| Number of Gates | - |
| Voltage - Supply | 0.82V ~ 0.88V |
| Mounting Type | Surface Mount |
| Operating Temperature | -40°C ~ 100°C (TJ) |
| Package / Case | 1932-BBGA, FCBGA |
| Supplier Device Package | 1932-FBGA, FC (45x45) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/5sgxmabn2f45i3n |

Table 5 lists the maximum allowed input overshoot voltage and the duration of the overshoot voltage as a percentage of device lifetime. The maximum allowed overshoot duration is specified as a percentage of high time over the lifetime of the device. A DC signal is equivalent to 100% of the duty cycle. For example, a signal that overshoots to 3.95 V can be at 3.95 V for only ~21% over the lifetime of the device; for a device lifetime of 10 years, the overshoot duration amounts to ~2 years.

Table 5. Maximum Allowed Overshoot During Transitions

| Symbol | Description | Condition (V) | Overshoot Duration as % @ $T_J = 100^\circ\text{C}$ | Unit |
|---------|------------------|---------------|---|------|
| Vi (AC) | AC input voltage | 3.8 | 100 | % |
| | | 3.85 | 64 | % |
| | | 3.9 | 36 | % |
| | | 3.95 | 21 | % |
| | | 4 | 12 | % |
| | | 4.05 | 7 | % |
| | | 4.1 | 4 | % |
| | | 4.15 | 2 | % |
| | | 4.2 | 1 | % |

Figure 1. Stratix V Device Overshoot Duration



Recommended Operating Conditions

This section lists the functional operating limits for the AC and DC parameters for Stratix V devices. Table 6 lists the steady-state voltage and current values expected from Stratix V devices. Power supply ramps must all be strictly monotonic, without plateaus.

Table 6. Recommended Operating Conditions for Stratix V Devices (Part 1 of 2)

| Symbol | Description | Condition | Min ⁽⁴⁾ | Typ | Max ⁽⁴⁾ | Unit |
|----------------------------|---|------------|--------------------|------|--------------------|------|
| V_{CC} | Core voltage and periphery circuitry power supply (C1, C2, I2, and I3YY speed grades) | — | 0.87 | 0.9 | 0.93 | V |
| | Core voltage and periphery circuitry power supply (C2L, C3, C4, I2L, I3, I3L, and I4 speed grades) ⁽³⁾ | — | 0.82 | 0.85 | 0.88 | V |
| V_{CCPT} | Power supply for programmable power technology | — | 1.45 | 1.50 | 1.55 | V |
| V_{CC_AUX} | Auxiliary supply for the programmable power technology | — | 2.375 | 2.5 | 2.625 | V |
| V_{CCPD} ⁽¹⁾ | I/O pre-driver (3.0 V) power supply | — | 2.85 | 3.0 | 3.15 | V |
| | I/O pre-driver (2.5 V) power supply | — | 2.375 | 2.5 | 2.625 | V |
| V_{CCIO} | I/O buffers (3.0 V) power supply | — | 2.85 | 3.0 | 3.15 | V |
| | I/O buffers (2.5 V) power supply | — | 2.375 | 2.5 | 2.625 | V |
| | I/O buffers (1.8 V) power supply | — | 1.71 | 1.8 | 1.89 | V |
| | I/O buffers (1.5 V) power supply | — | 1.425 | 1.5 | 1.575 | V |
| | I/O buffers (1.35 V) power supply | — | 1.283 | 1.35 | 1.45 | V |
| | I/O buffers (1.25 V) power supply | — | 1.19 | 1.25 | 1.31 | V |
| | I/O buffers (1.2 V) power supply | — | 1.14 | 1.2 | 1.26 | V |
| | Configuration pins (3.0 V) power supply | — | 2.85 | 3.0 | 3.15 | V |
| V_{CCPGM} | Configuration pins (2.5 V) power supply | — | 2.375 | 2.5 | 2.625 | V |
| | Configuration pins (1.8 V) power supply | — | 1.71 | 1.8 | 1.89 | V |
| V_{CCA_FPLL} | PLL analog voltage regulator power supply | — | 2.375 | 2.5 | 2.625 | V |
| V_{CCD_FPLL} | PLL digital voltage regulator power supply | — | 1.45 | 1.5 | 1.55 | V |
| V_{CCBAT} ⁽²⁾ | Battery back-up power supply (For design security volatile key register) | — | 1.2 | — | 3.0 | V |
| V_I | DC input voltage | — | -0.5 | — | 3.6 | V |
| V_0 | Output voltage | — | 0 | — | V_{CCIO} | V |
| T_J | Operating junction temperature | Commercial | 0 | — | 85 | °C |
| | | Industrial | -40 | — | 100 | °C |

Table 12. OCT Without Calibration Resistance Tolerance Specifications for Stratix V Devices (Part 2 of 2)

| Symbol | Description | Conditions | Resistance Tolerance | | | | Unit |
|---------------------|--|----------------------------|-----------------------------|---------------|-------------------------|---------------|-------------|
| | | | C1 | C2, I2 | C3, I3, I3YY | C4, I4 | |
| 50- Ω R_S | Internal series termination without calibration (50- Ω setting) | $V_{CCIO} = 1.8$ and 1.5 V | ± 30 | ± 30 | ± 40 | ± 40 | % |
| 50- Ω R_S | Internal series termination without calibration (50- Ω setting) | $V_{CCIO} = 1.2$ V | ± 35 | ± 35 | ± 50 | ± 50 | % |
| 100- Ω R_D | Internal differential termination (100- Ω setting) | $V_{CCPD} = 2.5$ V | ± 25 | ± 25 | ± 25 | ± 25 | % |

Calibration accuracy for the calibrated series and parallel OCTs are applicable at the moment of calibration. When voltage and temperature conditions change after calibration, the tolerance may change.

OCT calibration is automatically performed at power-up for OCT-enabled I/Os. Table 13 lists the OCT variation with temperature and voltage after power-up calibration. Use Table 13 to determine the OCT variation after power-up calibration and Equation 1 to determine the OCT variation without recalibration.

Equation 1. OCT Variation Without Recalibration for Stratix V Devices (1), (2), (3), (4), (5), (6)

$$R_{OCT} = R_{SCAL} \left(1 + \langle \frac{dR}{dT} \times \Delta T \rangle \pm \langle \frac{dR}{dV} \times \Delta V \rangle \right)$$

Notes to Equation 1:

- (1) The R_{OCT} value shows the range of OCT resistance with the variation of temperature and V_{CCIO} .
- (2) R_{SCAL} is the OCT resistance value at power-up.
- (3) ΔT is the variation of temperature with respect to the temperature at power-up.
- (4) ΔV is the variation of voltage with respect to the V_{CCIO} at power-up.
- (5) dR/dT is the percentage change of R_{SCAL} with temperature.
- (6) dR/dV is the percentage change of R_{SCAL} with voltage.

Table 13 lists the on-chip termination variation after power-up calibration.

Table 13. OCT Variation after Power-Up Calibration for Stratix V Devices (Part 1 of 2)⁽¹⁾

| Symbol | Description | V_{CCIO} (V) | Typical | Unit |
|---------------|--|----------------------------------|----------------|-------------|
| dR/dV | OCT variation with voltage without recalibration | 3.0 | 0.0297 | %/mV |
| | | 2.5 | 0.0344 | |
| | | 1.8 | 0.0499 | |
| | | 1.5 | 0.0744 | |
| | | 1.2 | 0.1241 | |

Table 18. Single-Ended SSTL, HSTL, and HSUL I/O Reference Voltage Specifications for Stratix V Devices

| I/O Standard | V _{CCIO} (V) | | | V _{REF} (V) | | | V _{TT} (V) | | |
|-------------------------|-----------------------|------|-------|-----------------------------|-------------------------|-----------------------------|-----------------------------|-------------------------|----------------------------|
| | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |
| SSTL-2 Class I, II | 2.375 | 2.5 | 2.625 | 0.49 * V _{CCIO} | 0.5 * V _{CCIO} | 0.51 * V _{CCIO} | V _{REF} – 0.04 | V _{REF} | V _{REF} + 0.04 |
| SSTL-18 Class I, II | 1.71 | 1.8 | 1.89 | 0.833 | 0.9 | 0.969 | V _{REF} – 0.04 | V _{REF} | V _{REF} + 0.04 |
| SSTL-15 Class I, II | 1.425 | 1.5 | 1.575 | 0.49 * V _{CCIO} | 0.5 * V _{CCIO} | 0.51 * V _{CCIO} | 0.49 * V _{CCIO} | 0.5 * V _{CCIO} | 0.51 * V _{CCIO} |
| SSTL-135 Class I, II | 1.283 | 1.35 | 1.418 | 0.49 * V _{CCIO} | 0.5 * V _{CCIO} | 0.51 * V _{CCIO} | 0.49 * V _{CCIO} | 0.5 * V _{CCIO} | 0.51 * V _{CCIO} |
| SSTL-125 Class I, II | 1.19 | 1.25 | 1.26 | 0.49 * V _{CCIO} | 0.5 * V _{CCIO} | 0.51 * V _{CCIO} | 0.49 * V _{CCIO} | 0.5 * V _{CCIO} | 0.51 * V _{CCIO} |
| SSTL-12 Class I, II | 1.14 | 1.20 | 1.26 | 0.49 * V _{CCIO} | 0.5 * V _{CCIO} | 0.51 * V _{CCIO} | 0.49 * V _{CCIO} | 0.5 * V _{CCIO} | 0.51 * V _{CCIO} |
| HSTL-18 Class I, II | 1.71 | 1.8 | 1.89 | 0.85 | 0.9 | 0.95 | — | V _{CCIO} /2 | — |
| HSTL-15 Class I, II | 1.425 | 1.5 | 1.575 | 0.68 | 0.75 | 0.9 | — | V _{CCIO} /2 | — |
| HSTL-12 Class I, II | 1.14 | 1.2 | 1.26 | 0.47 * V _{CCIO} | 0.5 * V _{CCIO} | 0.53 * V _{CCIO} | — | V _{CCIO} /2 | — |
| HSUL-12 | 1.14 | 1.2 | 1.3 | 0.49 * V _{CCIO} | 0.5 * V _{CCIO} | 0.51 * V _{CCIO} | — | — | — |

Table 19. Single-Ended SSTL, HSTL, and HSUL I/O Standards Signal Specifications for Stratix V Devices (Part 1 of 2)

| I/O Standard | V _{IL(DC)} (V) | | V _{IH(DC)} (V) | | V _{IL(AC)} (V) | V _{IH(AC)} (V) | V _{OL} (V) | V _{OH} (V) | I _{ol} (mA) | I _{oh} (mA) |
|-------------------------|-------------------------|-----------------------------|-----------------------------|----------------------------|-----------------------------|-----------------------------|----------------------------|-----------------------------|----------------------|----------------------|
| | Min | Max | Min | Max | | | | | | |
| SSTL-2 Class I | -0.3 | V _{REF} – 0.15 | V _{REF} + 0.15 | V _{CCIO} + 0.3 | V _{REF} – 0.31 | V _{REF} + 0.31 | V _{TT} – 0.608 | V _{TT} + 0.608 | 8.1 | -8.1 |
| SSTL-2 Class II | -0.3 | V _{REF} – 0.15 | V _{REF} + 0.15 | V _{CCIO} + 0.3 | V _{REF} – 0.31 | V _{REF} + 0.31 | V _{TT} – 0.81 | V _{TT} + 0.81 | 16.2 | -16.2 |
| SSTL-18 Class I | -0.3 | V _{REF} – 0.125 | V _{REF} + 0.125 | V _{CCIO} + 0.3 | V _{REF} – 0.25 | V _{REF} + 0.25 | V _{TT} – 0.603 | V _{TT} + 0.603 | 6.7 | -6.7 |
| SSTL-18 Class II | -0.3 | V _{REF} – 0.125 | V _{REF} + 0.125 | V _{CCIO} + 0.3 | V _{REF} – 0.25 | V _{REF} + 0.25 | 0.28 | V _{CCIO} – 0.28 | 13.4 | -13.4 |
| SSTL-15 Class I | — | V _{REF} – 0.1 | V _{REF} + 0.1 | — | V _{REF} – 0.175 | V _{REF} + 0.175 | 0.2 * V _{CCIO} | 0.8 * V _{CCIO} | 8 | -8 |
| SSTL-15 Class II | — | V _{REF} – 0.1 | V _{REF} + 0.1 | — | V _{REF} – 0.175 | V _{REF} + 0.175 | 0.2 * V _{CCIO} | 0.8 * V _{CCIO} | 16 | -16 |
| SSTL-135 Class I, II | — | V _{REF} – 0.09 | V _{REF} + 0.09 | — | V _{REF} – 0.16 | V _{REF} + 0.16 | 0.2 * V _{CCIO} | 0.8 * V _{CCIO} | — | — |
| SSTL-125 Class I, II | — | V _{REF} – 0.85 | V _{REF} + 0.85 | — | V _{REF} – 0.15 | V _{REF} + 0.15 | 0.2 * V _{CCIO} | 0.8 * V _{CCIO} | — | — |
| SSTL-12 Class I, II | — | V _{REF} – 0.1 | V _{REF} + 0.1 | — | V _{REF} – 0.15 | V _{REF} + 0.15 | 0.2 * V _{CCIO} | 0.8 * V _{CCIO} | — | — |

Table 21. Differential HSTL and HSUL I/O Standards for Stratix V Devices (Part 2 of 2)

| I/O Standard | V _{CCIO} (V) | | | V _{DIF(DC)} (V) | | V _{X(AC)} (V) | | | V _{CM(DC)} (V) | | | V _{DIF(AC)} (V) | |
|---------------------|-----------------------|-----|------|--------------------------|-------------------------|------------------------------|------|-------------------|-------------------------|------|------|--------------------------|--------------------------|
| | Min | Typ | Max | Min | Max | Min | Typ | Max | Min | Typ | Max | Min | Max |
| HSTL-12 Class I, II | 1.14 | 1.2 | 1.26 | 0.16 | V _{CCIO} + 0.3 | — | 0.5* | V _{CCIO} | 0.4* | 0.5* | 0.6* | 0.3 | V _{CCIO} + 0.48 |
| HSUL-12 | 1.14 | 1.2 | 1.3 | 0.26 | 0.26 | 0.5*V _{CCIO} - 0.12 | 0.5* | V _{CCIO} | 0.4* | 0.5* | 0.6* | 0.44 | 0.44 |

Table 22. Differential I/O Standard Specifications for Stratix V Devices (7)

| I/O Standard | V _{CCIO} (V) (10) | | | V _{ID} (mV) (8) | | | V _{ICM(DC)} (V) | | | V _{OD} (V) (6) | | | V _{OCM} (V) (6) | | |
|---------------------|--|-----|-------|--------------------------|--------------------------|-----|--------------------------|-----------------------------|-------|-------------------------|-----|-----|--------------------------|------|-------|
| | Min | Typ | Max | Min | Condition | Max | Min | Condition | Max | Min | Typ | Max | Min | Typ | Max |
| PCML | Transmitter, receiver, and input reference clock pins of the high-speed transceivers use the PCML I/O standard. For transmitter, receiver, and reference clock I/O pin specifications, refer to Table 23 on page 18. | | | | | | | | | | | | | | |
| 2.5 V LVDS (1) | 2.375 | 2.5 | 2.625 | 100 | V _{CM} = 1.25 V | — | 0.05 | D _{MAX} ≤ 700 Mbps | 1.8 | 0.247 | — | 0.6 | 1.125 | 1.25 | 1.375 |
| | | | | | | — | 1.05 | D _{MAX} > 700 Mbps | 1.55 | 0.247 | — | 0.6 | 1.125 | 1.25 | 1.375 |
| BLVDS (5) | 2.375 | 2.5 | 2.625 | 100 | — | — | — | — | — | — | — | — | — | — | — |
| RSDS (HIO) (2) | 2.375 | 2.5 | 2.625 | 100 | V _{CM} = 1.25 V | — | 0.3 | — | 1.4 | 0.1 | 0.2 | 0.6 | 0.5 | 1.2 | 1.4 |
| Mini-LVDS (HIO) (3) | 2.375 | 2.5 | 2.625 | 200 | — | 600 | 0.4 | — | 1.325 | 0.25 | — | 0.6 | 1 | 1.2 | 1.4 |
| LVPECL (4), (9) | — | — | — | 300 | — | — | 0.6 | D _{MAX} ≤ 700 Mbps | 1.8 | — | — | — | — | — | — |
| | — | — | — | 300 | — | — | 1 | D _{MAX} > 700 Mbps | 1.6 | — | — | — | — | — | — |

Notes to Table 22:

- (1) For optimized LVDS receiver performance, the receiver voltage input range must be between 1.0 V to 1.6 V for data rates above 700 Mbps, and 0 V to 1.85 V for data rates below 700 Mbps.
- (2) For optimized RSDS receiver performance, the receiver voltage input range must be between 0.25 V to 1.45 V.
- (3) For optimized Mini-LVDS receiver performance, the receiver voltage input range must be between 0.3 V to 1.425 V.
- (4) For optimized LVPECL receiver performance, the receiver voltage input range must be between 0.85 V to 1.75 V for data rate above 700 Mbps and 0.45 V to 1.95 V for data rate below 700 Mbps.
- (5) There are no fixed V_{CM}, V_{OD}, and V_{OCM} specifications for BLVDS. They depend on the system topology.
- (6) RL range: 90 ≤ RL ≤ 110 Ω.
- (7) The 1.4-V and 1.5-V PCML transceiver I/O standard specifications are described in “Transceiver Performance Specifications” on page 18.
- (8) The minimum VID value is applicable over the entire common mode range, V_{CM}.
- (9) LVPECL is only supported on dedicated clock input pins.
- (10) Differential inputs are powered by V_{CCPD} which requires 2.5 V.

Power Consumption

Altera offers two ways to estimate power consumption for a design—the Excel-based Early Power Estimator and the Quartus® II PowerPlay Power Analyzer feature.

Table 23. Transceiver Specifications for Stratix V GX and GS Devices ⁽¹⁾ (Part 2 of 7)

| Symbol/ Description | Conditions | Transceiver Speed Grade 1 | | | Transceiver Speed Grade 2 | | | Transceiver Speed Grade 3 | | | Unit |
|--|--|----------------------------------|------------------|------|----------------------------------|------------------|------|----------------------------------|------------------|------|-------------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Spread-spectrum downspread | PCIe | — | 0 to -0.5 | — | — | 0 to -0.5 | — | — | 0 to -0.5 | — | % |
| On-chip termination resistors ⁽²⁾ | — | — | 100 | — | — | 100 | — | — | 100 | — | Ω |
| Absolute V _{MAX} ⁽⁵⁾ | Dedicated reference clock pin | — | — | 1.6 | — | — | 1.6 | — | — | 1.6 | V |
| | RX reference clock pin | — | — | 1.2 | — | — | 1.2 | — | — | 1.2 | |
| Absolute V _{MIN} | — | -0.4 | — | — | -0.4 | — | — | -0.4 | — | — | V |
| Peak-to-peak differential input voltage | — | 200 | — | 1600 | 200 | — | 1600 | 200 | — | 1600 | mV |
| V _{ICM} (AC coupled) ⁽³⁾ | Dedicated reference clock pin | 1050/1000/900/850 ⁽²⁾ | | | 1050/1000/900/850 ⁽²⁾ | | | 1050/1000/900/850 ⁽²⁾ | | | mV |
| | RX reference clock pin | 1.0/0.9/0.85 ⁽⁴⁾ | | | 1.0/0.9/0.85 ⁽⁴⁾ | | | 1.0/0.9/0.85 ⁽⁴⁾ | | | V |
| V _{ICM} (DC coupled) | HCSL I/O standard for PCIe reference clock | 250 | — | 550 | 250 | — | 550 | 250 | — | 550 | mV |
| Transmitter REFCLK Phase Noise (622 MHz) ⁽²⁰⁾ | 100 Hz | — | — | -70 | — | — | -70 | — | — | -70 | dBc/Hz |
| | 1 kHz | — | — | -90 | — | — | -90 | — | — | -90 | dBc/Hz |
| | 10 kHz | — | — | -100 | — | — | -100 | — | — | -100 | dBc/Hz |
| | 100 kHz | — | — | -110 | — | — | -110 | — | — | -110 | dBc/Hz |
| | ≥1 MHz | — | — | -120 | — | — | -120 | — | — | -120 | dBc/Hz |
| Transmitter REFCLK Phase Jitter (100 MHz) ⁽¹⁷⁾ | 10 kHz to 1.5 MHz (PCIe) | — | — | 3 | — | — | 3 | — | — | 3 | ps (rms) |
| R _{REF} ⁽¹⁹⁾ | — | — | 1800 ±1% | — | — | 1800 ±1% | — | — | 180 0 ±1% | — | Ω |
| Transceiver Clocks | | | | | | | | | | | |
| fixedclk clock frequency | PCIe Receiver Detect | — | 100 or 125 | — | — | 100 or 125 | — | — | 100 or 125 | — | MHz |

Table 25 shows the approximate maximum data rate using the standard PCS.

Table 25. Stratix V Standard PCS Approximate Maximum Date Rate (1), (3)

| Mode (2) | Transceiver Speed Grade | PMA Width | 20 | 20 | 16 | 16 | 10 | 10 | 8 | 8 |
|-----------------|--------------------------------|---------------------------------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|----------|
| | | PCS/Core Width | 40 | 20 | 32 | 16 | 20 | 10 | 16 | 8 |
| FIFO | 1 | C1, C2, C2L, I2, I2L core speed grade | 12.2 | 11.4 | 9.76 | 9.12 | 6.5 | 5.8 | 5.2 | 4.72 |
| | 2 | C1, C2, C2L, I2, I2L core speed grade | 12.2 | 11.4 | 9.76 | 9.12 | 6.5 | 5.8 | 5.2 | 4.72 |
| | | C3, I3, I3L core speed grade | 9.8 | 9.0 | 7.84 | 7.2 | 5.3 | 4.7 | 4.24 | 3.76 |
| | 3 | C1, C2, C2L, I2, I2L core speed grade | 8.5 | 8.5 | 8.5 | 8.5 | 6.5 | 5.8 | 5.2 | 4.72 |
| | | I3YY core speed grade | 10.3125 | 10.3125 | 7.84 | 7.2 | 5.3 | 4.7 | 4.24 | 3.76 |
| | | C3, I3, I3L core speed grade | 8.5 | 8.5 | 7.84 | 7.2 | 5.3 | 4.7 | 4.24 | 3.76 |
| | | C4, I4 core speed grade | 8.5 | 8.2 | 7.04 | 6.56 | 4.8 | 4.2 | 3.84 | 3.44 |
| Register | 1 | C1, C2, C2L, I2, I2L core speed grade | 12.2 | 11.4 | 9.76 | 9.12 | 6.1 | 5.7 | 4.88 | 4.56 |
| | 2 | C1, C2, C2L, I2, I2L core speed grade | 12.2 | 11.4 | 9.76 | 9.12 | 6.1 | 5.7 | 4.88 | 4.56 |
| | | C3, I3, I3L core speed grade | 9.8 | 9.0 | 7.92 | 7.2 | 4.9 | 4.5 | 3.96 | 3.6 |
| | 3 | C1, C2, C2L, I2, I2L core speed grade | 10.3125 | 10.3125 | 10.3125 | 10.3125 | 6.1 | 5.7 | 4.88 | 4.56 |
| | | I3YY core speed grade | 10.3125 | 10.3125 | 7.92 | 7.2 | 4.9 | 4.5 | 3.96 | 3.6 |
| | | C3, I3, I3L core speed grade | 8.5 | 8.5 | 7.92 | 7.2 | 4.9 | 4.5 | 3.96 | 3.6 |
| | | C4, I4 core speed grade | 8.5 | 8.2 | 7.04 | 6.56 | 4.4 | 4.1 | 3.52 | 3.28 |

Notes to Table 25:

- (1) The maximum data rate is in Gbps.
- (2) The Phase Compensation FIFO can be configured in FIFO mode or register mode. In the FIFO mode, the pointers are not fixed, and the latency can vary. In the register mode the pointers are fixed for low latency.
- (3) The maximum data rate is also constrained by the transceiver speed grade. Refer to Table 1 for the transceiver speed grade.

Table 28. Transceiver Specifications for Stratix V GT Devices (Part 1 of 5)⁽¹⁾

| Symbol/ Description | Conditions | Transceiver Speed Grade 2 | | | Transceiver Speed Grade 3 | | | Unit | |
|--|--|---|-----------|------|------------------------------|-----------|------|------|--|
| | | Min | Typ | Max | Min | Typ | Max | | |
| Reference Clock | | | | | | | | | |
| Supported I/O Standards | Dedicated reference clock pin | 1.2-V PCML, 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, Differential LVPECL, LVDS, and HCSL | | | | | | | |
| | RX reference clock pin | 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS | | | | | | | |
| Input Reference Clock Frequency (CMU PLL) ⁽⁶⁾ | — | 40 | — | 710 | 40 | — | 710 | MHz | |
| Input Reference Clock Frequency (ATX PLL) ⁽⁶⁾ | — | 100 | — | 710 | 100 | — | 710 | MHz | |
| Rise time | 20% to 80% | — | — | 400 | — | — | 400 | ps | |
| Fall time | 80% to 20% | — | — | 400 | — | — | 400 | | |
| Duty cycle | — | 45 | — | 55 | 45 | — | 55 | % | |
| Spread-spectrum modulating clock frequency | PCI Express (PCIe) | 30 | — | 33 | 30 | — | 33 | kHz | |
| Spread-spectrum downspread | PCIe | — | 0 to -0.5 | — | — | 0 to -0.5 | — | % | |
| On-chip termination resistors ⁽¹⁹⁾ | — | — | 100 | — | — | 100 | — | Ω | |
| Absolute V _{MAX} ⁽³⁾ | Dedicated reference clock pin | — | — | 1.6 | — | — | 1.6 | V | |
| | RX reference clock pin | — | — | 1.2 | — | — | 1.2 | | |
| Absolute V _{MIN} | — | -0.4 | — | — | -0.4 | — | — | V | |
| Peak-to-peak differential input voltage | — | 200 | — | 1600 | 200 | — | 1600 | mV | |
| V _{ICM} (AC coupled) | Dedicated reference clock pin | 1050/1000 ⁽²⁾ | | | 1050/1000 ⁽²⁾ | | | mV | |
| | RX reference clock pin | 1.0/0.9/0.85 ⁽²²⁾ | | | 1.0/0.9/0.85 ⁽²²⁾ | | | V | |
| V _{ICM} (DC coupled) | HCSL I/O standard for PCIe reference clock | 250 | — | 550 | 250 | — | 550 | mV | |

Table 31. PLL Specifications for Stratix V Devices (Part 2 of 3)

| Symbol | Parameter | Min | Typ | Max | Unit |
|--|---|------------|------------|--|-------------|
| t_{INCCJ} ^{(3), (4)} | Input clock cycle-to-cycle jitter ($f_{REF} \geq 100$ MHz) | — | — | 0.15 | UI (p-p) |
| | Input clock cycle-to-cycle jitter ($f_{REF} < 100$ MHz) | -750 | — | +750 | ps (p-p) |
| t_{OUTPJ_DC} ⁽⁵⁾ | Period Jitter for dedicated clock output ($f_{OUT} \geq 100$ MHz) | — | — | 175 ⁽¹⁾ | ps (p-p) |
| | Period Jitter for dedicated clock output ($f_{OUT} < 100$ MHz) | — | — | 17.5 ⁽¹⁾ | mUI (p-p) |
| t_{FOUTPJ_DC} ⁽⁵⁾ | Period Jitter for dedicated clock output in fractional PLL ($f_{OUT} \geq 100$ MHz) | — | — | 250 ⁽¹¹⁾ , 175 ⁽¹²⁾ | ps (p-p) |
| | Period Jitter for dedicated clock output in fractional PLL ($f_{OUT} < 100$ MHz) | — | — | 25 ⁽¹¹⁾ , 17.5 ⁽¹²⁾ | mUI (p-p) |
| t_{OUTCCJ_DC} ⁽⁵⁾ | Cycle-to-Cycle Jitter for a dedicated clock output ($f_{OUT} \geq 100$ MHz) | — | — | 175 | ps (p-p) |
| | Cycle-to-Cycle Jitter for a dedicated clock output ($f_{OUT} < 100$ MHz) | — | — | 17.5 | mUI (p-p) |
| $t_{FOUTCCJ_DC}$ ⁽⁵⁾ | Cycle-to-cycle Jitter for a dedicated clock output in fractional PLL ($f_{OUT} \geq 100$ MHz) | — | — | 250 ⁽¹¹⁾ , 175 ⁽¹²⁾ | ps (p-p) |
| | Cycle-to-cycle Jitter for a dedicated clock output in fractional PLL ($f_{OUT} < 100$ MHz)+ | — | — | 25 ⁽¹¹⁾ , 17.5 ⁽¹²⁾ | mUI (p-p) |
| t_{OUTPJ_IO} ^{(5), (8)} | Period Jitter for a clock output on a regular I/O in integer PLL ($f_{OUT} \geq 100$ MHz) | — | — | 600 | ps (p-p) |
| | Period Jitter for a clock output on a regular I/O ($f_{OUT} < 100$ MHz) | — | — | 60 | mUI (p-p) |
| t_{FOUTPJ_IO} ^{(5), (8), (11)} | Period Jitter for a clock output on a regular I/O in fractional PLL ($f_{OUT} \geq 100$ MHz) | — | — | 600 ⁽¹⁰⁾ | ps (p-p) |
| | Period Jitter for a clock output on a regular I/O in fractional PLL ($f_{OUT} < 100$ MHz) | — | — | 60 ⁽¹⁰⁾ | mUI (p-p) |
| t_{OUTCCJ_IO} ^{(5), (8)} | Cycle-to-cycle Jitter for a clock output on a regular I/O in integer PLL ($f_{OUT} \geq 100$ MHz) | — | — | 600 | ps (p-p) |
| | Cycle-to-cycle Jitter for a clock output on a regular I/O in integer PLL ($f_{OUT} < 100$ MHz) | — | — | 60 ⁽¹⁰⁾ | mUI (p-p) |
| $t_{FOUTCCJ_IO}$ ^{(5), (8), (11)} | Cycle-to-cycle Jitter for a clock output on a regular I/O in fractional PLL ($f_{OUT} \geq 100$ MHz) | — | — | 600 ⁽¹⁰⁾ | ps (p-p) |
| | Cycle-to-cycle Jitter for a clock output on a regular I/O in fractional PLL ($f_{OUT} < 100$ MHz) | — | — | 60 | mUI (p-p) |
| $t_{CASC_OUTPJ_DC}$ ^{(5), (6)} | Period Jitter for a dedicated clock output in cascaded PLLs ($f_{OUT} \geq 100$ MHz) | — | — | 175 | ps (p-p) |
| | Period Jitter for a dedicated clock output in cascaded PLLs ($f_{OUT} < 100$ MHz) | — | — | 17.5 | mUI (p-p) |
| f_{DRIFT} | Frequency drift after PFDENA is disabled for a duration of 100 μ s | — | — | ± 10 | % |
| dK_{BIT} | Bit number of Delta Sigma Modulator (DSM) | 8 | 24 | 32 | Bits |
| k_{VALUE} | Numerator of Fraction | 128 | 8388608 | 2147483648 | — |

Table 36. High-Speed I/O Specifications for Stratix V Devices⁽¹⁾, ⁽²⁾ (Part 2 of 4)

| Symbol | Conditions | C1 | | | C2, C2L, I2, I2L | | | C3, I3, I3L, I3YY | | | C4,I4 | | | Unit |
|---|--|------------|------------|------------|-------------------------|------------|------------|--------------------------|------------|------------|--------------|------------|------------|-------------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Transmitter | | | | | | | | | | | | | | |
| True Differential I/O Standards - f_{HSDR} (data rate) | SERDES factor J = 3 to 10 ^{(9), (11), (12), (13), (14), (15), (16)} | (6) | — | 1600 | (6) | — | 1434 | (6) | — | 1250 | (6) | — | 1050 | Mbps |
| | SERDES factor J ≥ 4 LVDS TX with DPA ^{(12), (14), (15), (16)} | (6) | — | 1600 | (6) | — | 1600 | (6) | — | 1600 | (6) | — | 1250 | Mbps |
| | SERDES factor J = 2, uses DDR Registers | (6) | — | (7) | (6) | — | (7) | (6) | — | (7) | (6) | — | (7) | Mbps |
| | SERDES factor J = 1, uses SDR Register | (6) | — | (7) | (6) | — | (7) | (6) | — | (7) | (6) | — | (7) | Mbps |
| Emulated Differential I/O Standards with Three External Output Resistor Networks - f_{HSDR} (data rate) ⁽¹⁰⁾ | SERDES factor J = 4 to 10 ⁽¹⁷⁾ | (6) | — | 1100 | (6) | — | 1100 | (6) | — | 840 | (6) | — | 840 | Mbps |
| $t_{x\text{Jitter}}$ - True Differential I/O Standards | Total Jitter for Data Rate 600 Mbps - 1.25 Gbps | — | — | 160 | — | — | 160 | — | — | 160 | — | — | 160 | ps |
| | Total Jitter for Data Rate < 600 Mbps | — | — | 0.1 | — | — | 0.1 | — | — | 0.1 | — | — | 0.1 | UI |
| Total Jitter for Data Rate 600 Mbps - 1.25 Gbps | Total Jitter for Data Rate 600 Mbps - 1.25 Gbps | — | — | 300 | — | — | 300 | — | — | 300 | — | — | 325 | ps |
| | Total Jitter for Data Rate < 600 Mbps | — | — | 0.2 | — | — | 0.2 | — | — | 0.2 | — | — | 0.25 | UI |

Table 36. High-Speed I/O Specifications for Stratix V Devices^{(1), (2)} (Part 3 of 4)

| Symbol | Conditions | C1 | | | C2, C2L, I2, I2L | | | C3, I3, I3L, I3YY | | | C4,I4 | | | Unit |
|--|---|------------|------------|------------|-------------------------|------------|------------|--------------------------|------------|------------|--------------|------------|------------|-------------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| t _{DUTY} | Transmitter output clock duty cycle for both True and Emulated Differential I/O Standards | 45 | 50 | 55 | 45 | 50 | 55 | 45 | 50 | 55 | 45 | 50 | 55 | % |
| t _{RISE} & t _{FALL} | True Differential I/O Standards | — | — | 160 | — | — | 160 | — | — | 200 | — | — | 200 | ps |
| | Emulated Differential I/O Standards with three external output resistor networks | — | — | 250 | — | — | 250 | — | — | 250 | — | — | 300 | ps |
| TCCS | True Differential I/O Standards | — | — | 150 | — | — | 150 | — | — | 150 | — | — | 150 | ps |
| | Emulated Differential I/O Standards | — | — | 300 | — | — | 300 | — | — | 300 | — | — | 300 | ps |
| Receiver | | | | | | | | | | | | | | |
| True Differential I/O Standards - f _{HSDRDPA} (data rate) | SERDES factor J = 3 to 10 ^{(11), (12), (13), (14), (15), (16)} | 150 | — | 1434 | 150 | — | 1434 | 150 | — | 1250 | 150 | — | 1050 | Mbps |
| | SERDES factor J ≥ 4 LVDS RX with DPA ^{(12), (14), (15), (16)} | 150 | — | 1600 | 150 | — | 1600 | 150 | — | 1600 | 150 | — | 1250 | Mbps |
| | SERDES factor J = 2, uses DDR Registers | (6) | — | (7) | (6) | — | (7) | (6) | — | (7) | (6) | — | (7) | Mbps |
| | SERDES factor J = 1, uses SDR Register | (6) | — | (7) | (6) | — | (7) | (6) | — | (7) | (6) | — | (7) | Mbps |

Figure 7 shows the dynamic phase alignment (DPA) lock time specifications with the DPA PLL calibration option enabled.

Figure 7. DPA Lock Time Specification with DPA PLL Calibration Enabled

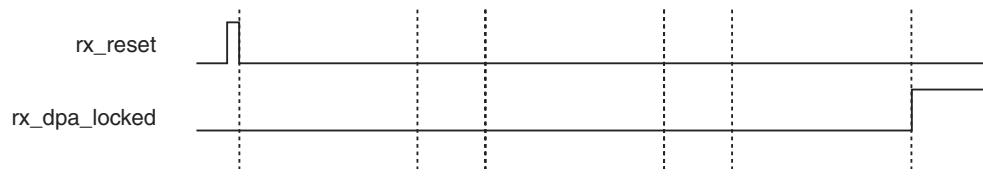


Table 37 lists the DPA lock time specifications for Stratix V devices.

Table 37. DPA Lock Time Specifications for Stratix V GX Devices Only^{(1), (2), (3)}

| Standard | Training Pattern | Number of Data Transitions in One Repetition of the Training Pattern | Number of Repetitions per 256 Data Transitions ⁽⁴⁾ | Maximum |
|--------------------|--------------------|--|---|----------------------|
| SPI-4 | 000000000011111111 | 2 | 128 | 640 data transitions |
| Parallel Rapid I/O | 00001111 | 2 | 128 | 640 data transitions |
| | 10010000 | 4 | 64 | 640 data transitions |
| Miscellaneous | 10101010 | 8 | 32 | 640 data transitions |
| | 01010101 | 8 | 32 | 640 data transitions |

Notes to Table 37:

- (1) The DPA lock time is for one channel.
- (2) One data transition is defined as a 0-to-1 or 1-to-0 transition.
- (3) The DPA lock time stated in this table applies to both commercial and industrial grade.
- (4) This is the number of repetitions for the stated training pattern to achieve the 256 data transitions.

Figure 8 shows the LVDS soft-clock data recovery (CDR)/DPA sinusoidal jitter tolerance specification for a data rate ≥ 1.25 Gbps. Table 38 lists the LVDS soft-CDR/DPA sinusoidal jitter tolerance specification for a data rate ≥ 1.25 Gbps.

Figure 8. LVDS Soft-CDR/DPA Sinusoidal Jitter Tolerance Specification for a Data Rate ≥ 1.25 Gbps

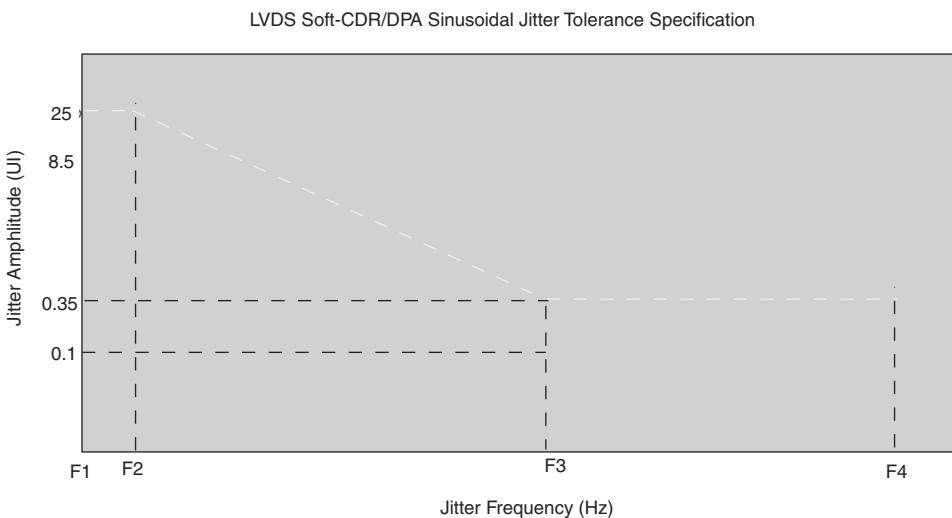


Table 42. Memory Output Clock Jitter Specification for Stratix V Devices⁽¹⁾, (Part 2 of 2)⁽²⁾, (3)

| Clock Network | Parameter | Symbol | C1 | | C2, C2L, I2, I2L | | C3, I3, I3L, I3YY | | C4,I4 | | Unit |
|---------------|------------------------------|-----------------|-------|------|------------------|------|-------------------|-----|-------|-----|------|
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| PHY Clock | Clock period jitter | $t_{JIT(per)}$ | -25 | 25 | -25 | 25 | -30 | 30 | -35 | 35 | ps |
| | Cycle-to-cycle period jitter | $t_{JIT(cc)}$ | -50 | 50 | -50 | 50 | -60 | 60 | -70 | 70 | ps |
| | Duty cycle jitter | $t_{JIT(duty)}$ | -37.5 | 37.5 | -37.5 | 37.5 | -45 | 45 | -56 | 56 | ps |

Notes to Table 42:

- (1) The clock jitter specification applies to the memory output clock pins generated using differential signal-splitter and DDIO circuits clocked by a PLL output routed on a PHY, regional, or global clock network as specified. Altera recommends using PHY clock networks whenever possible.
- (2) The clock jitter specification applies to the memory output clock pins clocked by an integer PLL.
- (3) The memory output clock jitter is applicable when an input jitter of 30 ps peak-to-peak is applied with bit error rate (BER) -12, equivalent to 14 sigma.

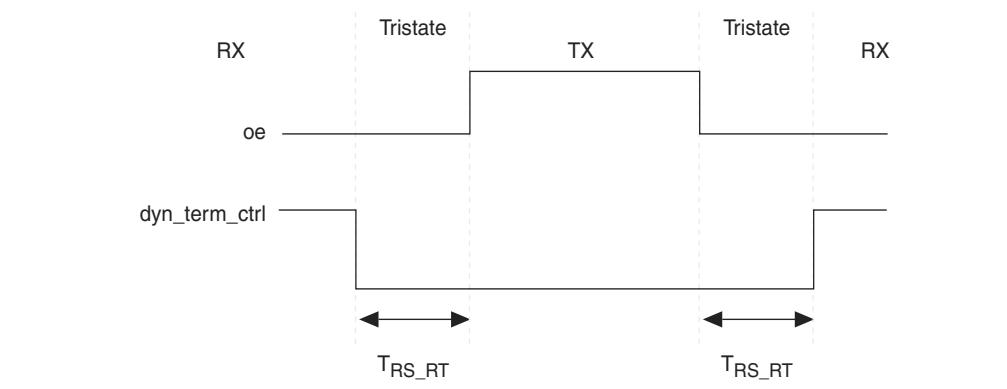
OCT Calibration Block Specifications

Table 43 lists the OCT calibration block specifications for Stratix V devices.

Table 43. OCT Calibration Block Specifications for Stratix V Devices

| Symbol | Description | Min | Typ | Max | Unit |
|----------------|---|-----|------|-----|--------|
| OCTUSRCLK | Clock required by the OCT calibration blocks | — | — | 20 | MHz |
| T_{OCTCAL} | Number of OCTUSRCLK clock cycles required for OCT R_S/R_T calibration | — | 1000 | — | Cycles |
| $T_{OCTSHIFT}$ | Number of OCTUSRCLK clock cycles required for the OCT code to shift out | — | 32 | — | Cycles |
| T_{RS_RT} | Time required between the <code>dyn_term_ctrl</code> and <code>oe</code> signal transitions in a bidirectional I/O buffer to dynamically switch between OCT R_S and R_T (Figure 10) | — | 2.5 | — | ns |

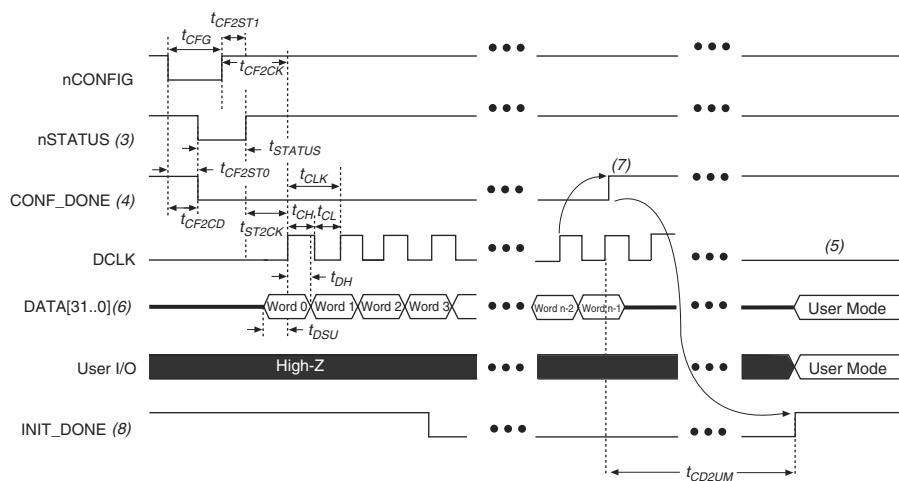
Figure 10 shows the timing diagram for the `oe` and `dyn_term_ctrl` signals.

Figure 10. Timing Diagram for oe and dyn_term_ctrl Signals

FPP Configuration Timing when DCLK-to-DATA [] = 1

Figure 12 shows the timing waveform for FPP configuration when using a MAX II or MAX V device as an external host. This waveform shows timing when the DCLK-to-DATA [] ratio is 1.

Figure 12. FPP Configuration Timing Waveform When the DCLK-to-DATA[] Ratio is 1 (1), (2)



Notes to Figure 12:

- (1) Use this timing waveform when the DCLK-to-DATA[] ratio is 1.
- (2) The beginning of this waveform shows the device in user mode. In user mode, nCONFIG, nSTATUS, and CONF_DONE are at logic-high levels. When nCONFIG is pulled low, a reconfiguration cycle begins.
- (3) After power-up, the Stratix V device holds nSTATUS low for the time of the POR delay.
- (4) After power-up, before and during configuration, CONF_DONE is low.
- (5) Do not leave DCLK floating after configuration. DCLK is ignored after configuration is complete. It can toggle high or low if required.
- (6) For FPP $\times 16$, use DATA [15 .. 0]. For FPP $\times 8$, use DATA [7 .. 0]. DATA [31 .. 0] are available as a user I/O pin after configuration. The state of this pin depends on the dual-purpose pin settings.
- (7) To ensure a successful configuration, send the entire configuration data to the Stratix V device. CONF_DONE is released high when the Stratix V device receives all the configuration data successfully. After CONF_DONE goes high, send two additional falling edges on DCLK to begin initialization and enter user mode.
- (8) After the option bit to enable the INIT_DONE pin is configured into the device, the INIT_DONE goes low.

Table 51 lists the timing parameters for Stratix V devices for FPP configuration when the DCLK-to-DATA [] ratio is more than 1.

Table 51. FPP Timing Parameters for Stratix V Devices When the DCLK-to-DATA[] Ratio is >1⁽¹⁾

| Symbol | Parameter | Minimum | Maximum | Units |
|-------------------|---|--|----------------------|-------|
| t_{CF2CD} | nCONFIG low to CONF_DONE low | — | 600 | ns |
| t_{CF2ST0} | nCONFIG low to nSTATUS low | — | 600 | ns |
| t_{CFG} | nCONFIG low pulse width | 2 | — | μs |
| t_{STATUS} | nSTATUS low pulse width | 268 | 1,506 ⁽²⁾ | μs |
| t_{CF2ST1} | nCONFIG high to nSTATUS high | — | 1,506 ⁽²⁾ | μs |
| $t_{CF2CK}^{(5)}$ | nCONFIG high to first rising edge on DCLK | 1,506 | — | μs |
| $t_{ST2CK}^{(5)}$ | nSTATUS high to first rising edge of DCLK | 2 | — | μs |
| t_{DSU} | DATA [] setup time before rising edge on DCLK | 5.5 | — | ns |
| t_{DH} | DATA [] hold time after rising edge on DCLK | $N-1/f_{DCLK}^{(5)}$ | — | s |
| t_{CH} | DCLK high time | $0.45 \times 1/f_{MAX}$ | — | s |
| t_{CL} | DCLK low time | $0.45 \times 1/f_{MAX}$ | — | s |
| t_{CLK} | DCLK period | $1/f_{MAX}$ | — | s |
| f_{MAX} | DCLK frequency (FPP ×8/×16) | — | 125 | MHz |
| | DCLK frequency (FPP ×32) | — | 100 | MHz |
| t_R | Input rise time | — | 40 | ns |
| t_F | Input fall time | — | 40 | ns |
| t_{CD2UM} | CONF_DONE high to user mode ⁽³⁾ | 175 | 437 | μs |
| t_{CD2CU} | CONF_DONE high to CLKUSR enabled | $4 \times$ maximum DCLK period | — | — |
| t_{CD2UMC} | CONF_DONE high to user mode with CLKUSR option on | $t_{CD2CU} + (8576 \times$ CLKUSR period) ⁽⁴⁾ | — | — |

Notes to Table 51:

- (1) Use these timing parameters when you use the decompression and design security features.
- (2) You can obtain this value if you do not delay configuration by extending the nCONFIG or nSTATUS low pulse width.
- (3) The minimum and maximum numbers apply only if you use the internal oscillator as the clock source for initializing the device.
- (4) To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the Initialization section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.
- (5) N is the DCLK-to-DATA ratio and f_{DCLK} is the DCLK frequency the system is operating.
- (6) If nSTATUS is monitored, follow the t_{ST2CK} specification. If nSTATUS is not monitored, follow the t_{CF2CK} specification.

Table 54 lists the PS configuration timing parameters for Stratix V devices.

Table 54. PS Timing Parameters for Stratix V Devices

| Symbol | Parameter | Minimum | Maximum | Units |
|-------------------|---|--|----------------------|-------|
| t_{CF2CD} | nCONFIG low to CONF_DONE low | — | 600 | ns |
| t_{CF2ST0} | nCONFIG low to nSTATUS low | — | 600 | ns |
| t_{CFG} | nCONFIG low pulse width | 2 | — | μs |
| t_{STATUS} | nSTATUS low pulse width | 268 | 1,506 ⁽¹⁾ | μs |
| t_{CF2ST1} | nCONFIG high to nSTATUS high | — | 1,506 ⁽²⁾ | μs |
| $t_{CF2CK}^{(5)}$ | nCONFIG high to first rising edge on DCLK | 1,506 | — | μs |
| $t_{ST2CK}^{(5)}$ | nSTATUS high to first rising edge of DCLK | 2 | — | μs |
| t_{DSU} | DATA [] setup time before rising edge on DCLK | 5.5 | — | ns |
| t_{DH} | DATA [] hold time after rising edge on DCLK | 0 | — | ns |
| t_{CH} | DCLK high time | $0.45 \times 1/f_{MAX}$ | — | s |
| t_{CL} | DCLK low time | $0.45 \times 1/f_{MAX}$ | — | s |
| t_{CLK} | DCLK period | $1/f_{MAX}$ | — | s |
| f_{MAX} | DCLK frequency | — | 125 | MHz |
| t_{CD2UM} | CONF_DONE high to user mode ⁽³⁾ | 175 | 437 | μs |
| t_{CD2CU} | CONF_DONE high to CLKUSR enabled | 4 × maximum DCLK period | — | — |
| t_{CD2UMC} | CONF_DONE high to user mode with CLKUSR option on | $t_{CD2CU} + (8576 \times \text{CLKUSR period})^{(4)}$ | — | — |

Notes to Table 54:

- (1) This value is applicable if you do not delay configuration by extending the nCONFIG or nSTATUS low pulse width.
- (2) This value is applicable if you do not delay configuration by externally holding the nSTATUS low.
- (3) The minimum and maximum numbers apply only if you choose the internal oscillator as the clock source for initializing the device.
- (4) To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the “Initialization” section.
- (5) If nSTATUS is monitored, follow the t_{ST2CK} specification. If nSTATUS is not monitored, follow the t_{CF2CK} specification.

Initialization

Table 55 lists the initialization clock source option, the applicable configuration schemes, and the maximum frequency.

Table 55. Initialization Clock Source Option and the Maximum Frequency

| Initialization Clock Source | Configuration Schemes | Maximum Frequency | Minimum Number of Clock Cycles ⁽¹⁾ |
|-----------------------------|----------------------------|-------------------|---|
| Internal Oscillator | AS, PS, FPP | 12.5 MHz | 8576 |
| CLKUSR | AS, PS, FPP ⁽²⁾ | 125 MHz | |
| DCLK | PS, FPP | 125 MHz | |

Notes to Table 55:

- (1) The minimum number of clock cycles required for device initialization.
- (2) To enable CLKUSR as the initialization clock source, turn on the **Enable user-supplied start-up clock (CLKUSR)** option in the Quartus II software from the **General** panel of the **Device and Pin Options** dialog box.

Remote System Upgrades

Table 56 lists the timing parameter specifications for the remote system upgrade circuitry.

Table 56. Remote System Upgrade Circuitry Timing Specifications

| Parameter | Minimum | Maximum | Unit |
|-----------------------------|---------|---------|------|
| trU_nCONFIG ⁽¹⁾ | 250 | — | ns |
| trU_nRSTIMER ⁽²⁾ | 250 | — | ns |

Notes to Table 56:

- (1) This is equivalent to strobing the reconfiguration input of the ALTREMOTE_UPDATE megafunction high for the minimum timing specification. For more information, refer to the Remote System Upgrade State Machine section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.
- (2) This is equivalent to strobing the reset_timer input of the ALTREMOTE_UPDATE megafunction high for the minimum timing specification. For more information, refer to the User Watchdog Timer section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.

User Watchdog Internal Circuitry Timing Specification

Table 57 lists the operating range of the 12.5-MHz internal oscillator.

Table 57. 12.5-MHz Internal Oscillator Specifications

| Minimum | Typical | Maximum | Units |
|---------|---------|---------|-------|
| 5.3 | 7.9 | 12.5 | MHz |

I/O Timing

Altera offers two ways to determine I/O timing—the Excel-based I/O Timing and the Quartus II Timing Analyzer.

Excel-based I/O timing provides pin timing performance for each device density and speed grade. The data is typically used prior to designing the FPGA to get an estimate of the timing budget as part of the link timing analysis. The Quartus II Timing Analyzer provides a more accurate and precise I/O timing data based on the specifics of the design after you complete place-and-route.

- You can download the Excel-based I/O Timing spreadsheet from the Stratix V Devices Documentation web page.

Programmable IOE Delay

Table 58 lists the Stratix V IOE programmable delay settings.

Table 58. IOE Programmable Delay for Stratix V Devices (Part 1 of 2)

| Parameter ⁽¹⁾ | Available Settings | Min Offset ⁽²⁾ | Fast Model | | Slow Model | | | | | | | |
|-----------------------------|-----------------------|---------------------------------|------------|------------|------------|-------|-------|-------|-------|-------------|-------|----|
| | | | Industrial | Commercial | C1 | C2 | C3 | C4 | I2 | I3, I3YY | | |
| D1 | 64 | 0 | 0.464 | 0.493 | 0.838 | 0.838 | 0.924 | 1.011 | 0.844 | 0.921 | 1.006 | ns |
| D2 | 32 | 0 | 0.230 | 0.244 | 0.415 | 0.415 | 0.459 | 0.503 | 0.417 | 0.456 | 0.500 | ns |

Table 60. Glossary (Part 2 of 4)

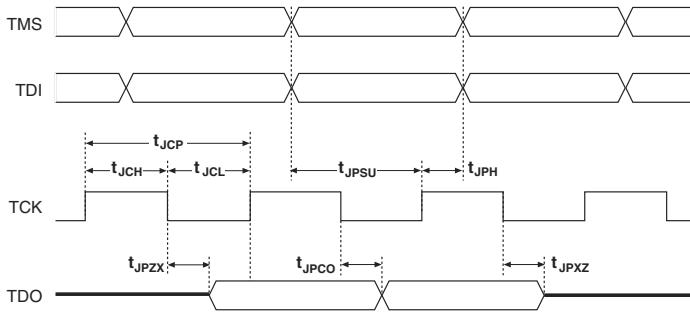
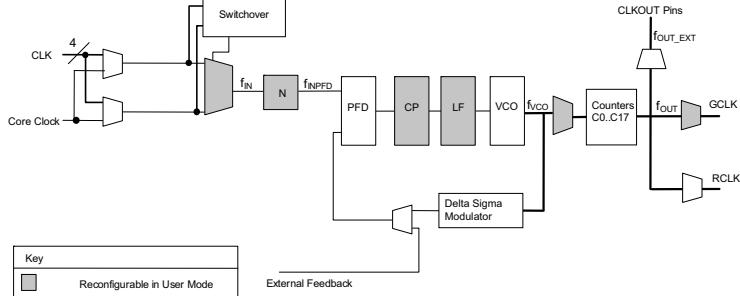
| Letter | Subject | Definitions |
|-----------------------|----------------------------|---|
| G H I | — | — |
| J | J | High-speed I/O block—Deserialization factor (width of parallel data bus). |
| J | JTAG Timing Specifications | JTAG Timing Specifications:  <p>The diagram illustrates the JTAG timing specifications for four signals: TMS, TDI, TCK, and TDO. The TMS and TDI signals are shown as continuous streams of pulses. The TCK signal is a clock signal with three distinct phases. The TDO signal is a data output signal. Various timing parameters are labeled: t_{JCP}, t_{JCH}, t_{JCL}, t_{JPZU}, t_{JPZC}, t_{JPXZ}, and t_{IPH}. These parameters define the timing constraints between the rising edges of TCK and the sampling or setup times for TMS, TDI, and TDO.</p> |
| K L M N O | — | — |
| P | PLL Specifications | Diagram of PLL Specifications (1)  <p>The diagram shows the internal architecture of a PLL. It starts with a Core Clock input, which is buffered and then divided by a factor of 4 to produce a reference clock. This reference clock is fed into a Phase Frequency Detector (PFD). The PFD also receives an external clock f_{IN} and its inverted version. The PFD's output is connected to a Charge Pump (CP) and a Loop Filter (LF). The LF feeds into a Voltage Controlled Oscillator (VCO). The VCO's output is fed back through a Delta Sigma Modulator to the PFD. The VCO also drives a counter block consisting of two counters, C0 and C17. The counter outputs are used to generate the GCLK and RCLK signals. Finally, the VCO output is buffered and labeled as f_{OUT_EXT}.</p> <p>Note: (1) Core Clock can only be fed by dedicated clock input pins or PLL outputs.</p> |
| Q | — | — |
| R | R _L | Receiver differential input discrete resistor (external to the Stratix V device). |

Table 61. Document Revision History (Part 3 of 3)

| Date | Version | Changes |
|---------------|---------|--|
| May 2013 | 2.7 | <ul style="list-style-type: none"> ■ Updated Table 2, Table 6, Table 7, Table 20, Table 23, Table 27, Table 47, Table 60 ■ Added Table 24, Table 48 ■ Updated Figure 9, Figure 10, Figure 11, Figure 12 |
| February 2013 | 2.6 | <ul style="list-style-type: none"> ■ Updated Table 7, Table 9, Table 20, Table 23, Table 27, Table 30, Table 31, Table 35, Table 46 ■ Updated “Maximum Allowed Overshoot and Undershoot Voltage” |
| December 2012 | 2.5 | <ul style="list-style-type: none"> ■ Updated Table 3, Table 6, Table 7, Table 8, Table 23, Table 24, Table 25, Table 27, Table 30, Table 32, Table 35 ■ Added Table 33 ■ Added “Fast Passive Parallel Configuration Timing” ■ Added “Active Serial Configuration Timing” ■ Added “Passive Serial Configuration Timing” ■ Added “Remote System Upgrades” ■ Added “User Watchdog Internal Circuitry Timing Specification” ■ Added “Initialization” ■ Added “Raw Binary File Size” |
| June 2012 | 2.4 | <ul style="list-style-type: none"> ■ Added Figure 1, Figure 2, and Figure 3. ■ Updated Table 1, Table 2, Table 3, Table 6, Table 11, Table 22, Table 23, Table 27, Table 29, Table 30, Table 31, Table 32, Table 35, Table 38, Table 39, Table 40, Table 41, Table 43, Table 56, and Table 59. ■ Various edits throughout to fix bugs. ■ Changed title of document to <i>Stratix V Device Datasheet</i>. ■ Removed document from the Stratix V handbook and made it a separate document. |
| February 2012 | 2.3 | <ul style="list-style-type: none"> ■ Updated Table 1–22, Table 1–29, Table 1–31, and Table 1–31. |
| December 2011 | 2.2 | <ul style="list-style-type: none"> ■ Added Table 2–31. ■ Updated Table 2–28 and Table 2–34. |
| November 2011 | 2.1 | <ul style="list-style-type: none"> ■ Added Table 2–2 and Table 2–21 and updated Table 2–5 with information about Stratix V GT devices. ■ Updated Table 2–11, Table 2–13, Table 2–20, and Table 2–25. ■ Various edits throughout to fix SPRs. |
| May 2011 | 2.0 | <ul style="list-style-type: none"> ■ Updated Table 2–4, Table 2–18, Table 2–19, Table 2–21, Table 2–22, Table 2–23, and Table 2–24. ■ Updated the “DQ Logic Block and Memory Output Clock Jitter Specifications” title. ■ Chapter moved to Volume 1. ■ Minor text edits. |
| December 2010 | 1.1 | <ul style="list-style-type: none"> ■ Updated Table 1–2, Table 1–4, Table 1–19, and Table 1–23. ■ Converted chapter to the new template. ■ Minor text edits. |
| July 2010 | 1.0 | Initial release. |

